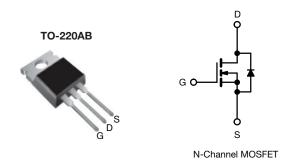


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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMAR	RY	
V_{DS} (V) at T _J max.	65	50
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.084
Q _g max. (nC)	10	34
Q _{gs} (nC)	1	6
Q _{gd} (nC)	4	8
Configuration	Sin	gle

FEATURES

- A specific on resistance (mΩ-cm²) reduction of 25 %
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP35N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	N
Gate-source voltage			V _{GS}	± 30	- V
Continuous drain surrant (T 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C		32	
Continuous drain current ($T_J = 150 \ ^\circ C$)	$V_{\rm GS}$ at 10 V	T _C = 100 °C	ID	20	Α
Pulsed drain current ^a			I _{DM}	80	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy ^b			E _{AS}	298	mJ
Maximum power dissipation		PD	250		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	n-source voltage slope $T_J = 125 \text{ °C}$		al / alt	100	
Reverse diode dv/dt ^d			dv/dt	50	V/ns
Soldering recommendations (peak temperature) ^c	For	10 s		260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.6 A

c. 1.6 mm from case

d. $I_{SD} = 17$ A, di/dt = 300 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	- 62				°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-		0.5		0/10		
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 10 mA	-	0.66	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2.0	-	4.0	V
Gate-source leakage		$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zara anto voltago droin ourront	1	V _{DS} =	: 480 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	', V _{GS} = 0 V	′, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	₀ = 17 A	-	0.084	0.097	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D =	= 17 A	-	8	-	S
Dynamic								
Input capacitance	C _{iss}		$V_{GS} = 0 V_{S}$		-	2568	-	
Output capacitance	C _{oss}		$V_{\rm DS} = 100$ V	V,	-	113	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz		-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	N 01	(+= 400 \/	V 0.V	-	81	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0$	/ to 480 V,	v _{GS} = 0 v	-	421	-	
Total gate charge	Qg				-	89	134	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 17 /	A, V _{DS} = 480 V	-	16	-	nC
Gate-drain charge	Q _{gd}	1			-	48	-	1
Turn-on delay time	t _{d(on)}		•		-	28	56	
Rise time	t _r	V _{DD} =	= 480 V, I _D =	= 17 A,	-	85	170	1
Turn-off delay time	t _{d(off)}		= 10 V, R _g =		-	96	192	ns
Fall time	t _f	1			-	61	122	1
Gate input resistance	R _g	f = 1	MHz, oper	n drain	0.2	0.5	1.0	Ω

Drain-Source Body Diode Characteristic	cs					
Continuous source-drain diode current	I _S	MOSFET symbol showing the	-	-	32	A
Pulsed diode forward current	I _{SM}	p - n junction diode	-	-	80	~
Diode forward voltage	V _{SD}	T_J = 25 °C, I_S = 17 A, V_{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	T 05 00 H H 47 A	-	150	300	ns
Reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 17 A, di/dt = 100 A/μs, V _B = 400 V	-	1.1	2.2	μC
Reverse recovery current	I _{RRM}		-	14	-	А

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

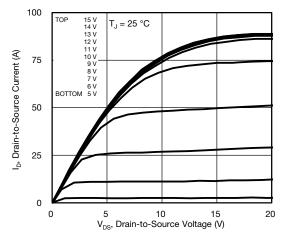


Fig. 1 - Typical Output Characteristics

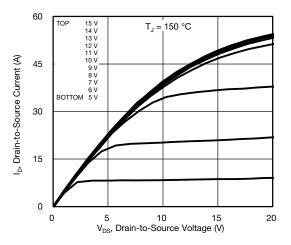


Fig. 2 - Typical Output Characteristics

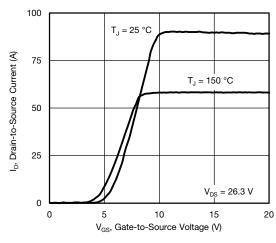


Fig. 3 - Typical Transfer Characteristics

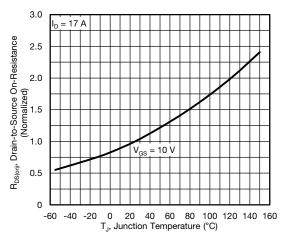


Fig. 4 - Normalized On-Resistance vs. Temperature

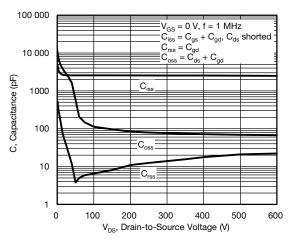


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

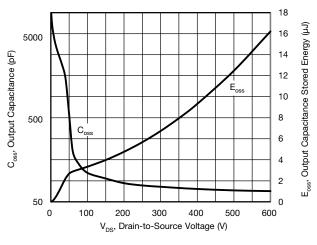


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92107

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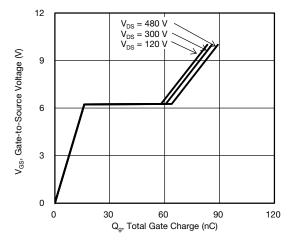


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

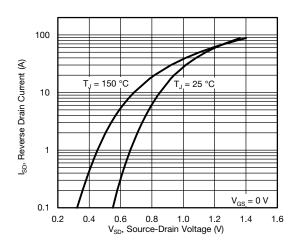


Fig. 8 - Typical Source-Drain Diode Forward Voltage

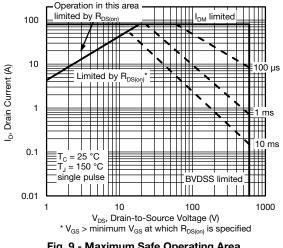


Fig. 9 - Maximum Safe Operating Area

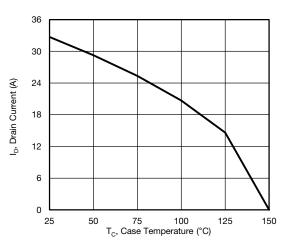


Fig. 10 - Maximum Drain Current vs. Case Temperature

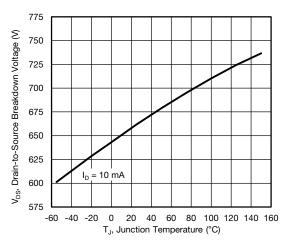
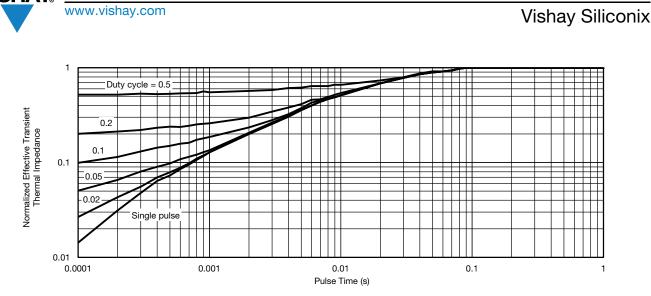
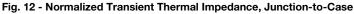


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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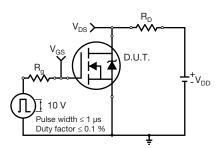


Fig. 13 - Switching Time Test Circuit

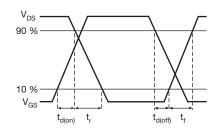


Fig. 14 - Switching Time Waveforms

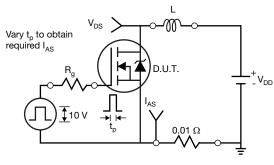
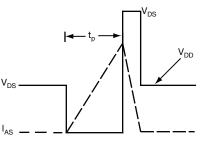


Fig. 15 - Unclamped Inductive Test Circuit

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SiHP35N60EF

Fig. 16 - Unclamped Inductive Waveforms

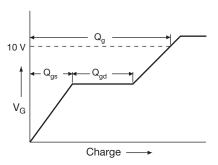
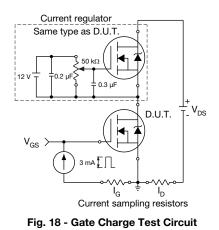


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

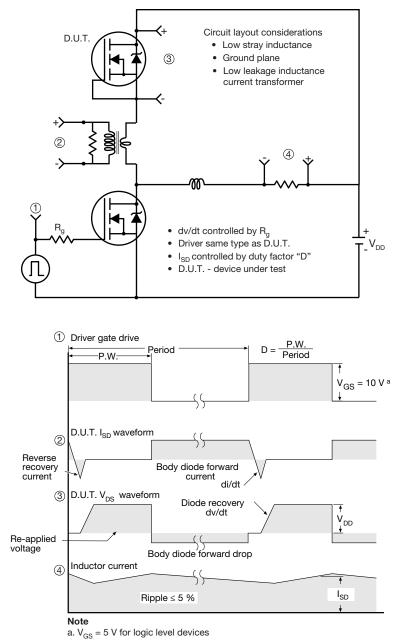


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon



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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?92107</u>.



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TO-220-1



DIM.	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Revison: 04-Nov-2021



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